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Dated: 12/8/04 Signature: Melody Almberg  
(Melody Almberg)

Docket No.: 291958171US4  
Client Ref No. P98-0025US8

(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Chen et al.

Application No.: 10/695,419

Confirmation Number: 4483

Filed: October 27, 2003

Art Unit: 2818

For: APPARATUS AND METHOD FOR  
ELECTROLYTICALLY DEPOSITING  
COPPER ON A SEMICONDUCTOR  
WORKPIECE

Examiner: P. T. Dang

**TRANSMITTAL OF DRAWING CORRECTION**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Submitted herewith are three sheets of replacement drawings. Drawings 2A, 5 and 7 have been corrected for the above-identified patent application.

Favorable consideration of the enclosed drawings is respectfully requested.

Application No.: 10/695,419

Docket No.: 291958171US4

Applicant believes no fee is due with this response. However, if a fee is due, please charge our Deposit Account No. 50-0665, under Order No. 291958171US4 from which the undersigned is authorized to draw.

Dated: December 8, 2004

Respectfully submitted,

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